LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司

Winstar Display Co., LTD 華凌光電股份有限公司



WEB: https://www.winstar.com.tw E-mail: sales@winstar.com.tw

SPECIFICATION

CUSTOMER:	
MODULE NO.:	WG320240C0-TFH-VZ#

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(FOR CUSTOMER USE ONLY)

PCB VERSION:

DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

VERSION	DATE	REVISED PAGE NO.	SUMMARY
N	2021/03/09		Add Interface Modify B/L information



MODLE NO:

華凌光電股份有限公司

RECORDS OF REVISION

DOC. FIRST ISSUE

		T	
VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2006/06/23		First issue
A	2008/11/03		Modify Backlight
			information
В	2011/11/14		Remove the VOP adjust
			circuit of outer.
С	2012/03/06		Modify Backlight
		40	information
D	2014/07/18		Modify VDD-Vo.
Е	2015/02/12		Modify contour drawing
F	2015/03/19		Correct contour drawing
G	2016/01/27		Modify Precautions in use
	1 C }		of LCD Modules
			& Static electricity test
H	2017/02/03		Modify Backlight
			Information
I	2018/07/31		Modify PCB.
J	2019/08/27		Modify Material List of
			Components for RoHs
K	2019/12/10	Modify Electrical	
			Characteristics

L	2019/12/17	Modify Precautions in use
		of LCD Modules
M	2020/07/22	Modify B/L information
N	2021/03/09	Add Interface
		Modify B/L information

Contents

- 1.Module Classification Information
- 2.Precautions in use of LCD Modules
- 3.General Specification
- 4. Absolute Maximum Ratings
- 5. Electrical Characteristics
- 6. Optical Characteristics
- 7.Interface Pin Function
- 8. Contour Drawing & Block Diagram
- 9.Reliability
- 10.Backlight Information
- 11.Inspection specification
- 12. Material List of Components for RoHs
- 13.Recommendable Storage

1. Module Classification Information

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type, X→TAB Type, O→COG Type

③ Display Font: 320 * 240 dot

Model serials no.

© Backlight Type: N \rightarrow Without backlight T \rightarrow LED, White L \rightarrow LED, Full color

 $B\rightarrow EL$, Blue green $A\rightarrow LED$, Amber $J\rightarrow DIP$ LED, Blue $D\rightarrow EL$, Green $R\rightarrow LED$, Red $K\rightarrow DIP$ LED, White

W→EL, White O→LED, Orange E→DIP LED, Yellow Green

 $M\rightarrow$ EL, Yellow Green $G\rightarrow$ LED, Green $H\rightarrow$ DIP LED, Amber $F\rightarrow$ CCFL, White $P\rightarrow$ LED, Blue $I\rightarrow$ DIP LED, Red

 $Y\rightarrow$ LED, Yellow Green $X\rightarrow$ LED, Dual color $G\rightarrow$ LED, Green $C\rightarrow$ LED, Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

 $H \rightarrow HTN$ Positive, Gray $F \rightarrow FSTN$ Positive $I \rightarrow HTN$ Negative, Black $K \rightarrow FSC$ Negative $U \rightarrow HTN$ Negative, Blue $S \rightarrow FSC$ Positive

M→STN Negative, Blue E→ISTN Negative, Black
G→STN Positive, Gray C→CSTN Negative, Black
Y→STN Positive, Yellow Green A→ASTN Negative, Black

② LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

Type/ Temperature D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00

range/ View G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00

direction J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00

 $E \rightarrow Transflective, N.T.12:00$ $L \rightarrow Transmissive, W.T,12:00$

Special Code
V : Built in negative voltage

Z:IC NT7086

#:Fit in with the ROHS Directions and regulations

2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

3.General Specification

Item	Dimension	Unit			
Number of dots	320 x 240 —				
Module dimension	148.02 x 120.24 x 16.0 (MAX) mm				
View area	120.14 x 92.14	mm			
Active area	115.18 x 86.38	mm			
Dot size	0.34 x 0.34	mm			
Dot pitch	0.36 x 0.36	mm			
LCD type	FSTN Positive , Transflective (In LCD production, It will occur slightly color difference. We can only guarantee the same color in the same batch.)				
Duty	1/240				
View direction	6 o'clock				
Backlight Type	LED White				
IC	RA8835				
Interface	68 series				

4.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	Тор	-20	_	+70	$^{\circ}$ C
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\!\mathbb{C}$
Input Voltage	$V_{ m IN}$	-0.3	_	V _{DD+0.3}	V
Supply Voltage For Logic	V_{DD} - V_{SS}	-0.3	_	7.0	V
Supply Voltage For LCD	V_{DD} - V_0	0	_	32	V

5.Electrical Characteristics

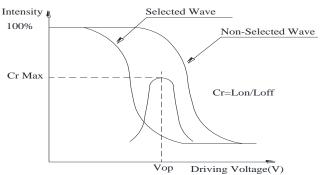
ITEM	SYMBOL	CONDITION	MIN.	TYP.	MAX.	UNIT
Supply Voltage For Logic	V_{DD} - V_{SS}	_	4.5	5.0	5.5	V
Supply Voltage For		Ta=-20°C	_	_	_	V
LCD	V_{DD} - V_{O}	Ta=25°℃	_	_	- X	V
* Note		Ta=70°C	_	_		V
Input High Volt.	V_{IH}	_	$0.5V_{DD}$	_	$ m V_{DD}$	V
Input Low Volt.	V_{IL}	_	V_{SS}	(-)	$0.2V_{\mathrm{DD}}$	V
Output High Volt.	$ m V_{OH}$	_	V _{DD} -0.4		_	V
Output Low Volt.	V_{OL}	_	1	_	V _{SS} +0.4	V
Supply Current	I_{DD}	V _{DD} =5.0V	90.0	100.0	105.0	mA

^{*} Note: The VOP of best contrast adjust via VR resistor

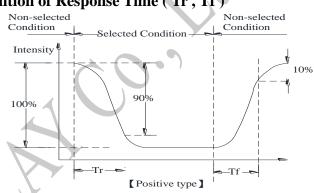
6.Optical Characteristics

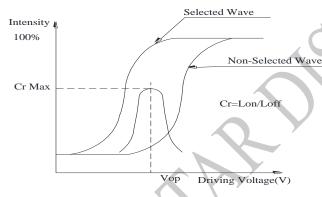
Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	30	$\phi = 180^{\circ}$
View Angle	θ	CR≧2	0	_	60	$\phi = 0^{\circ}$
	θ	CR≧2	0	_	45	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	45	$\phi = 270^{\circ}$
Contrast Ratio	CR	_	_	5	_	_
D T'	T rise	_	_	200	300	ms
Response Time	T fall	_	_	250	350	ms

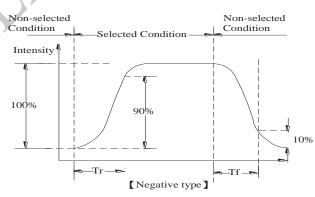
Definition of Operation Voltage (Vop)



Definition of Response Time (Tr, Tf)





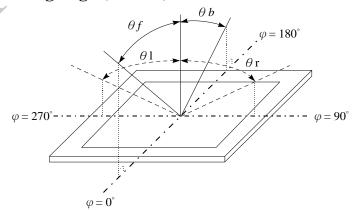


Conditions:

Operating Voltage : Vop Frame Frequency : 64 HZ Viewing Angle(θ , φ): 0° , 0°

Driving Waveform: 1/N duty, 1/a bias

Definition of viewing angle($CR \ge 2$)

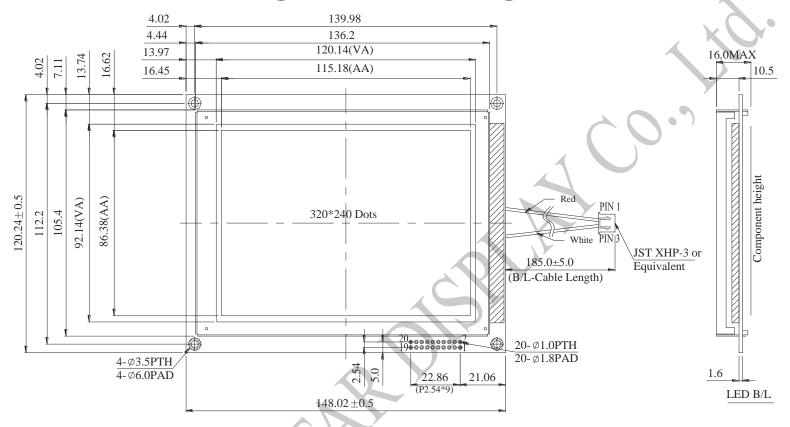


7.Interface Pin Function

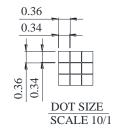
For 68 Family

Pin No.	Symbol	Level	Description			
1	Vss	0V	GND			
2	V_{DD}	5.0V	Power supply for Logic			
3	$V_{\rm O}$		No connection			
4	/RD	H/L	8080 family: Read signal,6800 family: Enable Clock			
5	/WR	H/L	8080 family: Write signal,6800 family: R/W signal			
6	A0		RD =L,WR=H A0=L: Data Read A0=H: Status read RD =H,WR=L A0=L: Data Write A0=H: Command write For80 Family RD =L,WR=H A0=L: Command write A0=H: Data read RD =H,WR=L A0=L: Status read A0=H: Data write For68 Family			
7~14	DB0~DB7	H/L	Data bus line			
15	/CS	H/L	Chip select ,Active L			
16	/RES	H/L	Controller reset signal, Active L			
17	Vee		Negative voltage output			
18	FGND	Y	Frame Ground			
19	NC	,	No connection			
20	NC		No connection			

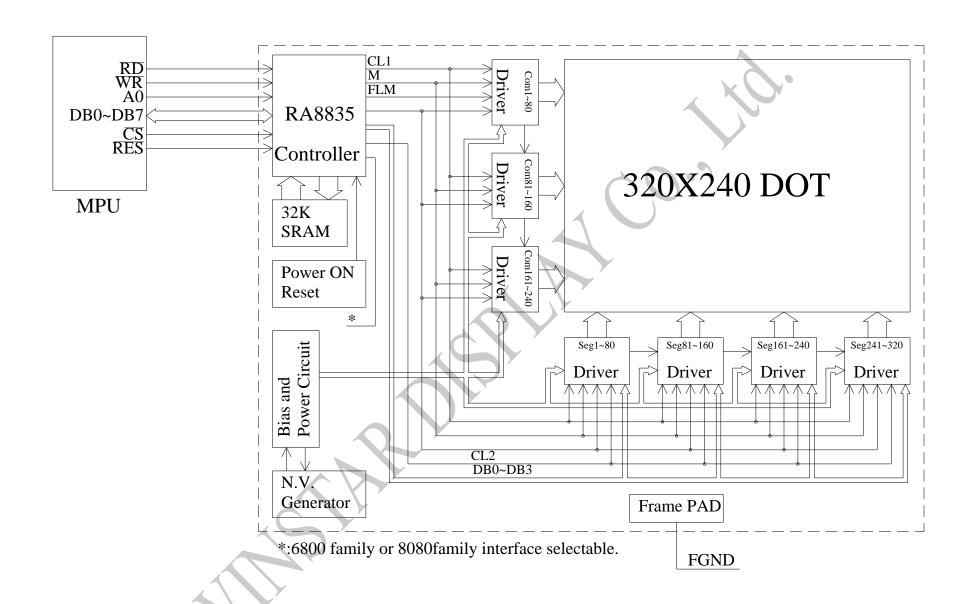
8.Contour Drawing & Block Diagram



PIN NO.	SYMBOL
1	Vss
2	Vdd
3	Vo
4	RD
5	WR
6	A0
7	DB0
8	DB1
9	DB2
10	DB3
11	DB4
12	DB5
13	DB6
14	DB7
15	CS
16	RES
17	Vee
18	FGND
19	NC
20	NC



The non-specified tolerance of dimension is ± 0.3 mm.



9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	Environmental Test		
Test Item	Content of Test	Test Condition	Not e
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs ▲	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330Ω CS=150pF 10 times	

Note1: No dew condensation to be observed.

Note 2: The function test shall be conducted after 4 hours storage at the normal ${\bf r}$

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

10.Backlight Information

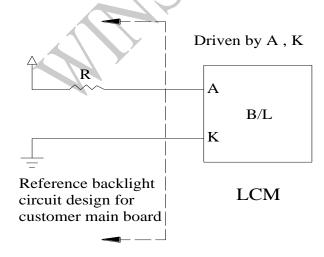
Specification

Parameter	Symbol	Min	Тур	Max	Unit	Test Condition
Supply Current	ILED	96	128	160	mA	V=3.5V(Note 1)
Supply Voltage	V	3.4	3.5	3.6	V	_
Reverse Voltage	VR	_	_	5	v	-
	X	0.25	0.28	0.31	_	H ED 128
Colour coordinate	Y	0.24	0.27	0.30	_	ILED=128mA
Luminance	IV	384	400		cd/m ²	ILED=128mA
(Without LCD)	1 V	384	480	_	ca/m-	ILED=128MA
LED Life Time				_	9	ILED=128mA
(For Reference	_	_	50K	_	Hr.	25℃,50-60%RH,
only)						(Note 2)
Color	White		C	-		

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1: Supply current minimum value is only for reference since LED brightness efficiency keeps enhancing. Current consumption becomes less and less to achieve the same luminance

Note 2:50K hours is only an estimate for reference.



11.Inspection specification

NO	Item	Criterion				AQL
		Missing vertical	, horizonta	al segment, segme	nt contrast defect.	
		Missing characte	er, dot or	icon.		
		Display malfund	ction.			
01	Electrical	No function or r	o display.			0.65
01	Testing	Current consum	ption exce	eds product specif	fications.	0.03
		LCD viewing ar	igle defect		~ (
		Mixed product t	ypes.			7
		Contrast defect.				
	Black or	2.1 White and h	laak a n ota	on display < 0.25	mm, no more than	
02	white spots on		-		min, no more man	2.5
02	LCD (display	three white or bl	-	-	on lines within 2mm	2.3
	only)	2.2 Delisely space	ced: No III	ore than two spots	s or lines within 3mm	
		3.1 Round type	: As follow	ving drawing		
		$\Phi = (x + y) / 2$		SIZE	Acceptable Q TY	
				Φ≦0.10	Accept no dense	
				$0.10 < \Phi \le 0.20$	2	
				$0.20 < \Phi \le 0.25$	1	2.5
				$0.25 < \Phi$	0	2.5
	I CD blook	v				
	LCD black	→ 1^ ← -	↓			
02	spots, white		_ Y			
03	spots,		Ť			
	(non display)	3.2 Line type : (As follow	ing drawing)		
	(non-display)	3111	Length	Width	Acceptable Q TY	
		_ /¥ w		W≤0.02	Accept no dense	
		<u> </u>	L≦3.0	$0.02 < W \le 0.03$		
		L	L≦2.5	$0.03 < W \le 0.05$	$\dashv 2$	2.5
	1			0.05 < W	As round type	
				I	- 22 73 333 17 7	

04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.	Size Φ $Φ \le 0.20$ $0.20 < Φ \le 0.50$ $0.50 < Φ \le 1.00$ $1.00 < Φ$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5
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NO	Item	Criterion			AQL
05	Scratches	Follow NO.3 LCD blace	ck spots, white spots, co	ntamination	
		Symbols Define:			
		x: Chip length y	: Chip width z: Ch	ip thickness	
		k: Seal width t:	Glass thickness a: LC	CD side length	
		L: Electrode pad length	n:		
		6.1 General glass chip	:		
		6.1.1 Chip on panel sur	face and crack between	panels:	
		z: Chip thickness	y: Chip width	x: Chip length	
06	Chipped	Z≦1/2t	Not over viewing area	x ≤ 1/8a	2.5
	glass	$1/2t < z \le 2t$	Not exceed 1/3k	x ≤ 1/8a	2.3
		⊙ If there are 2 or more 6.1.2 Corner crack:	e chips, x is total length	of each chip.	
	A	z: Chip thickness	y: Chip width	x: Chip length	
4		$Z \le 1/2t$	Not over viewing	$x \le 1/8a$	
	N Y	<u>L</u> <u>⇒</u> 1/2t	area	A ≥ 1/0a	
		$1/2t < z \le 2t$	Not exceed 1/3k	$x \le 1/8a$	
			e chips, x is the total len		
		of there are 2 of more	e emps, a is the total left	gui of each emp.	

NO	Item	Criterion			AQL
		Symbols:			
		•	ip width z: Chip	thickness	
			-	side length	
		L: Electrode pad length		•	
		6.2 Protrusion over termina	1:		
		6.2.1 Chip on electrode pad	:		
06	Glass		≦ 1/8a	$\frac{z}{z} \stackrel{\text{Chip thickness}}{\text{Chip thickness}}$	2.5
		y: Chip width	x: Chip length	z: Chip thickness	
		$y \le L$	$x \le 1/8a$	$0 < z \leq t$	
		remain and be inspected acc			
		⊙ If the product will be hear	•	-	
		be damaged.		···, ···· ···. ··· ··· ··· ··· ··· ··· ·	
		6.2.3 Substrate protuberanc	e and internal crack.		
		X	y: width	x: length	
			$y \le 1/3L$	$x \le a$	
		W. T.	•	" = "	
		24 (88) 3 - 5 (6) (78)			

NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
		8.1 Illumination source flickers when lit.	0.65
00	Backlight	8.2 Spots or scratched that appear when lit must be judged.	2.5
08	elements	Using LCD spot, lines and contamination standards.	
		8.3 Backlight doesn't light or color wrong.	0.65
		9.1 Bezel may not have rust, be deformed or have fingerprints,	2.5
09	Bezel	stains or other contamination.	
		9.2 Bezel must comply with job specifications.	0.65
		10.1 COB seal may not have pinholes larger than 0.2mm or contamination.	2.5
		10.2 COB seal surface may not have pinholes through to the IC.	2.5
		10.3 The height of the COB should not exceed the height	0.65
		indicated in the assembly diagram.	
		10.4 There may not be more than 2mm of sealant outside the	2.5
		seal area on the PCB. And there should be no more than three	
		places.	
		10.5 No oxidation or contamination PCB terminals.	2.5
10	PCB、COB	10.6 Parts on PCB must be the same as on the production	0.65
10	TCD COD	characteristic chart. There should be no wrong parts, missing	
		parts or excess parts.	
		10.7 The jumper on the PCB should conform to the product characteristic chart.	0.65
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or	2.5
		screw hold pad, make sure it is smoothed down.	
		10.9 The Scraping testing standard for Copper Coating of PCB	2.5
	150	x 2	
		$X * Y \le 2mm^2$	
4		11.1 No un-melted solder paste may be present on the PCB.	2.5
		11.2 No cold solder joints, missing solder connections,	2.5
11	Soldering	oxidation or icicle.	
		11.3 No residue or solder balls on PCB.	2.5
		11.4 No short circuits in components on PCB.	0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface	2.5
		Pin (OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to sever.	
	General	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12		component) is not burned into brown or black color.	
	appearance	12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

12.Material List of Components for

RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	Limited 100 1000 1000 1000 1000 1000 1000 100									
Value ppm ppm ppm ppm ppm ppm ppm ppm ppm pp										
Above limited value is set up according to RoHS.										

- 2.Process for RoHS requirement : (only for RoHS inspection)
 - (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
 - (2) Heat-resistance temp. :

Reflow: 250°C,30 seconds Max.;

Connector soldering wave or hand soldering: 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. $: 235\pm5^{\circ}C$;

Recommended customer's soldering temp. of connector: 280°C, 3 seconds.

13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.



winstar <u>LCM Sam</u> Module Number :		Feedback Sheet Page: 1
1 · Panel Specification :		Tuge. I
1. Panel Type:	Pass	□ NG,
2. View Direction:	Pass	□ NG ,
3. Numbers of Dots:	☐ Pass	□ NG ,
4. View Area:	☐ Pass	□ NG ,
5. Active Area:	☐ Pass	□ NG ,
6. Operating Temperature :	Pass	□ NG ,
7. Storage Temperature:	Pass	□ NG ,
8. Others:		
2 · Mechanical Specification :		
1. PCB Size:	☐ Pass	□ NG,
2. Frame Size:	Pass	□ NG,
3. Materal of Frame:	Pass	□ NG,
4. Connector Position:	Pass	□ NG,
5. Fix Hole Position:	Pass	□ NG,
6. Backlight Position:	Pass	□ NG,
7. Thickness of PCB:	Pass	□ NG ,
8. Height of Frame to PCB:	Pass	□ NG,
9. Height of Module:	Pass	□ NG,
10. Others:	☐ Pass	□ NG,
3 · Relative Hole Size:		
1. Pitch of Connector :	☐ Pass	□ NG ,
2. Hole size of Connector:	☐ Pass	□ NG ,
3. Mounting Hole size :	☐ Pass	□ NG ,
4. Mounting Hole Type:	☐ Pass	□ NG ,
5. Others:	☐ Pass	□ NG ,
4 · Backlight Specification :		
1. B/L Type:	☐ Pass	□ NG ,
2. B/L Color:	☐ Pass	□ NG ,
3. B/L Driving Voltage (Refer	ence for LED 7	
4. B/L Driving Current:	☐ Pass	□ NG ,
5. Brightness of B/L:	☐ Pass	□ NG ,
6. B/L Solder Method:	☐ Pass	□ NG ,
7. Others:	☐ Pass	□ NG ,
	>> Go to	page 2 <<

	1. Input Voltage:		
2. Supply Current:		☐ Pass	
3. Driving Voltage for LCD : Pass 4. Contrast for LCD : Pass 5. B/L Driving Method : Pass 6. Negative Voltage Output : Pass 7. Interface Function : Pass 8. LCD Uniformity : Pass 9. ESD test : Pass 10. Others : Pass	2. Supply Current:		□ NG ,
4. Contrast for LCD:		Pass	□ NG ,
5. B/L Driving Method:	3. Driving Voltage for LCD:	Pass	□ NG ,
6. Negative Voltage Output:	4. Contrast for LCD:	Pass	□ NG ,
7. Interface Function : Pass NG , 8. LCD Uniformity : Pass NG , 9. ESD test : Pass NG , 10. Others : Pass NG ,	5. B/L Driving Method:	Pass	□ NG ,
8. LCD Uniformity :	6. Negative Voltage Output:	Pass	□ NG ,
9. ESD test:	7. Interface Function:	Pass	□ NG ,
10. Others:	8. LCD Uniformity:	Pass	□ NG ,
	9. ESD test:	Pass	□ NG,
6 · Summary :	10. Others:	Pass	□ NG,